

3.0mm Round With Chip Resistor Built in LED Lamp

DESCRIPTION

Round Type

• 3.0mm Diameter

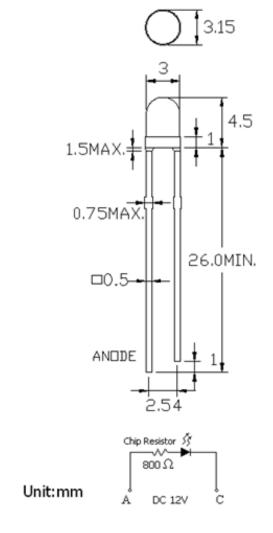
Lens Color: Red Diffused

FEATURES

Emitted Color: Super Red

Technology: GaAlAs

Viewing Angle: 76°



Note: All dimensions are in millimeters tolerance is ±0.25mm (±0.01inch) unless otherwise noted.

I	Dout Number	Matarial	Lens Color		
	Part Number	Material	Emitted	Lens	
	L314SRD-12V76D	GaAlAs	Super Red	Red Diffused	



3.0mm Round With Chip Resistor Built in LED Lamp

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Ratings	Unit
Peak Forward Current (duty 1/10 @ 1KHz)	I _{FP}	100	mA
Recommended Operating Current	I _{F(REC)}	20	mA
Power Dissipation	P _D	85	mW
Reverse Voltage	VR	5	V
Operating Temperature Range	TOPR	-40~+85	°C
Storage Temperature Range	T _{STG}	-40~+100	°C
Lead Soldering Temperature Range 1.6mm (1/16 inch) from body	Tsol	260°C for 5 sec	conds

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv	I _F =12mA	16	20	35	mcd
Peak Emission Wavelength	λр			660		nm
Dominant Wavelength	λ D			643		nm
Forward Voltage	VF		11	12	13	V
Spectral Line Half-Width	Δλ			20		nm
Viewing Angle	201/2			76		deg
Reverse Current	I _R	V _R =5V			10	μΑ



3.0mm Round With Chip Resistor Built in LED Lamp

Forward Current If(mA)

40

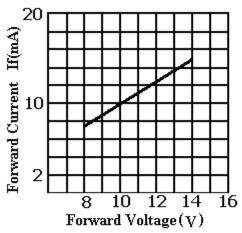
30

20

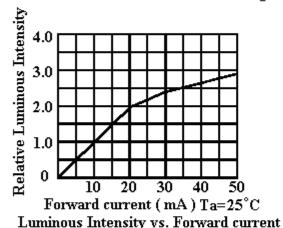
10

20

TYPICAL ELECTRICAL-OPTICAL CHARACTERISTIC CURVES



Forward current vs. Forward Voltage



Relative Luminous Intensity
0.5
0.2
-20 0 10 30 50 70

40

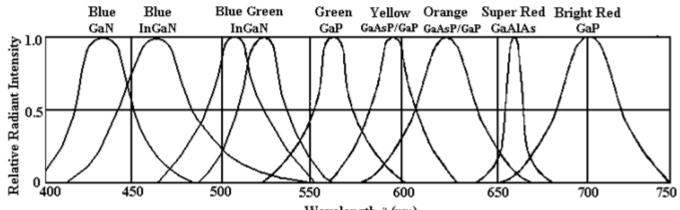
Ambient Temperature Ta= °C Forward current Derating curve

60

80

100

Ambient Temperature Ta= °C Luminous Intensity vs. Ambient Temperature



Wavelength \(\chi(nm)\)
RELATIVE INTENSITY VS. WAVELENGTH

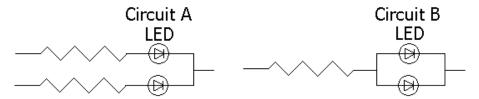


3.0mm Round With Chip Resistor Built in LED Lamp

PRECAUTIONS

1. Drive Method:

LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs, connect in parallel for application. It is recommended that a current limiting resistor be incorporated in the drive circuit.



- a. Circuit A is the recommended circuit.
- b. Circuit B, the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

2. Over-current proof:

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change and burn out will happen

Storage:

The Storage Temperature and RH are: 5°C ~ 30°C, RH 60% or less.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a moisture proof package with moisture absorbent material (i.e. silica gel). We suggest our customers to use our products within a year.

If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time, baking treatment should be performed using the following conditions.

Bake treat more than 24 hours at 60°C ±5°C.

4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs.

Suggestions to prevent ESD damage: Use a conductive wrist band or anti-electrostatic glove when handing these LEDs. All devices, equipment, and machinery must be properly grounded. Work tables, storage racks, etc. should be properly grounded. In the event of a manual working in process, make sure the devices are well protected from ESD at any time.

5. Other

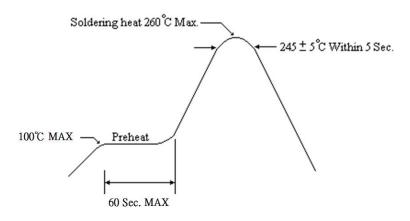
For uniform luminance and color, please use the same binning number and avoid using intermix. This shall prevent differences of luminance and color.



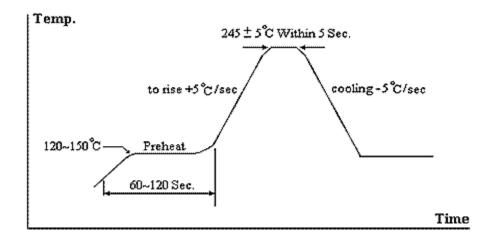
3.0mm Round With Chip Resistor Built in LED Lamp

RECOMMENDED SOLDERING CONDITION

Soldering heat (DIP)



REFLOW PROFILE



Soldering Iron

Temperature at tip of iron: 350°C Max Soldering time: 3 sec ±1 sec (once only)

If temperature is higher, time should be shorter



3.0mm Round With Chip Resistor Built in LED Lamp

RELIABILITY TEST

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25℃ IF:20mA	1000HRS	20PCS	0/1
2	High Temperature High Humidity	Temperature:85℃ 85%RH	1000HRS	20PCS	0/1
3	High Temperature Storage	Temperature:100℃	1000HRS	20PCS	0/1
4	Low Temperature Storage	Temperature: —40°℃	1000HRS	20PCS	0/1
5	Temperature Cycling	85°C~25°C~−35°C 15min~5min~15min	15Cycles	20PCS	0/1
6	Thermal Shock	85°C~25°C~−10°C 5min~10sec~5min	15Cycles	20PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	20PCS	0/1